

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IFW

Applicant: Joseph E. Geusic et al.

Title: INTEGRATED CIRCUITS USING OPTICAL FIBER INTERCONNECTS FORMED
THROUGH A SEMICONDUCTOR WAFER

Docket No.: 303.390US4

Filed: February 5, 2004

Examiner: Julio J Maldonado



Serial No.: 10/772,606

Due Date: October 28, 2005

Group Art Unit: 2823

MS Issue Fee

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

☒ Return postcard.

☒ Amendment Under 37 CFR 1.312 (12 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: 

Atty: Viet V. Tong

Reg. No. 45,416

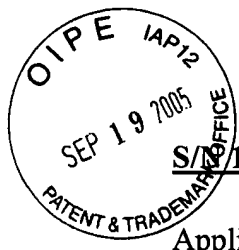
CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 15 day of September, 2005.

KACIA LEE
Name

Kacia Lee
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)



S/N/10/772,606

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Joseph E. Geusic et al.

Examiner: Julio J. Maldonado

Serial No.: 10/772,606

Group Art Unit: 2823

Filed: February 5, 2004

Docket: 303.390US4

Title: INTEGRATED CIRCUITS USING OPTICAL FIBER INTERCONNECTS
FORMED THROUGH A SEMICONDUCTOR WAFER

AMENDMENT UNDER 37 C.F.R. § 1.312

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Notice of Allowance and Notice of Allowability mailed July 28, 2005,
please amend the application as follows.